

EP 13 Core and accessories

Series/Type: B65843A, B65844 Date: October 2022

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# **公TDK**

B65843A

## EP 13

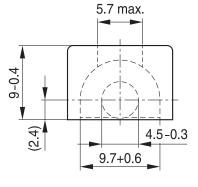
#### Core

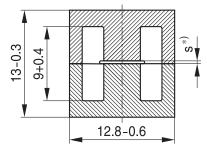
- To IEC 63093-5
- For transformers featuring high inductance and low overall height
- For power applications
- Delivery mode: sets

#### Magnetic characteristics (per set)

$$\begin{split} \Sigma I/A &= 1.24 \text{ mm}^{-1} \\ I_e &= 24.2 \text{ mm} \\ A_e &= 19.5 \text{ mm}^2 \\ A_{min} &= 14.9 \text{ mm}^2 \\ V_e &= 472 \text{ mm}^3 \end{split}$$

Approx. weight 4.5 g/set





\*) gapped (one-sided)

FEP0119-I-E

Material	A <sub>L</sub> value	s	μ <sub>e</sub>	Ordering code
		approx.		
	nH	mm		
T38	63 ±3%	0.39	62	B65843A0063A038
	100 ±3%	0.24	99	B65843A0100A038
	160 ±4%	0.15	158	B65843A0160B038
	200 ±4%	0.12	198	B65843A0200B038
	250 ±5%	0.10	247	B65843A0250J038
	315 ±6%	0.08	311	B65843A0315C038
	400 ±7%	0.06	395	B65843A0400E038
T57	63 ±3%	0.38	62	B65843A0063A057
	100 ±3%	0.24	99	B65843A0100A057
	160 ±4%	0.15	158	B65843A0160B057
	200 ±4%	0.12	198	B65843A0200B057
	250 ±5%	0.09	247	B65843A0250J057
	315 ±6%	0.07	311	B65843A0315C057
	400 ±7%	0.06	395	B65843A0400E057
N45	63 ±3%	0.38	62	B65843A0063A045
	100 ±3%	0.24	99	B65843A0100A045
	160 ±4%	0.15	158	B65843A0160B045
	200 ±4%	0.12	198	B65843A0200B045
	250 ±5%	0.09	247	B65843A0250J045
	315 ±6%	0.07	311	B65843A0315C045
	400 ±7%	0.05	395	B65843A0400E045

## Gapped (A<sub>L</sub> values/air gaps examples)

Please read *Cautions and warnings* and *Important notes* at the end of this document.

2



B65843A

## EP 13 Core

## Gapped

Material	A <sub>L</sub> value nH	s approx. mm	μ <sub>e</sub>	Ordering code
	1111			
N87	63 ±3%	0.37	62	B65843A0063A087
	100 ±3%	0.23	99	B65843A0100A087
	160 ±4%	0.14	158	B65843A0160B087
	200 ±4%	0.11	198	B65843A0200B087
	250 ±5%	0.09	247	B65843A0250J087
	315 ±6%	0.07	311	B65843A0315C087
	400 ±7%	0.05	395	B65843A0400E087

## Ungapped

Material	A <sub>L</sub> value	μ <sub>e</sub>	P <sub>V</sub>	Ordering code
	nH		W/set	
N45	2400 +30/-20%	2370		B65843A0000R045
T57	2500 +30/-20%	2470		B65843A0000R057
N30	2800 +30/-20%	2765		B65843A0000R030
T65	4000 +30/-20%	3950		B65843A0000R065
T38	7000 +40/-30%	6910		B65843A0000Y038
N49	1000 +30/-20%	990	< 0.06 ( 50 mT, 500 kHz, 100 °C)	B65843A0000R049
N87	1600 +30/–20%	1580	< 0.18 (200 mT, 100 kHz, 100 °C)	B65843A0000R087

Other A<sub>L</sub> values/air gaps and materials available on request – see Processing remarks on page 7.



## EP 13

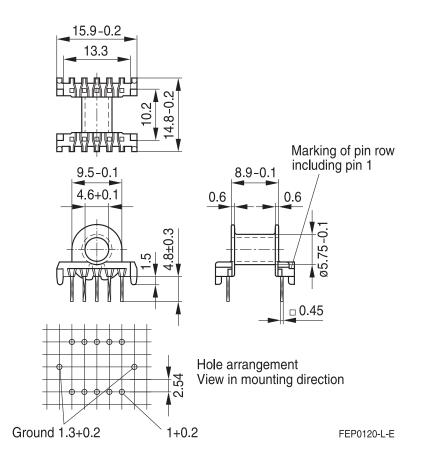
Accessories

#### Coil former, squared pins

Material:GFR thermosetting plastic (UL 94 V-0, insulation class to IEC 60085:<br/>F  $\triangleq$  max. operating temperature 155 °C), color code black<br/>Sumikon PM 9630® [E41429 (M)], SUMITOMO BAKELITE CO LTD<br/>Solderability:Solderability:to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s<br/>Resistance to soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 s

Winding: see Processing notes, 2.1

Sections	A <sub>N</sub> mm <sup>2</sup>	l <sub>N</sub> mm	A <sub>R</sub> value μΩ	Terminals	Ordering code
1	14.3	23.8	57.1	10	B65844W1010D001



4



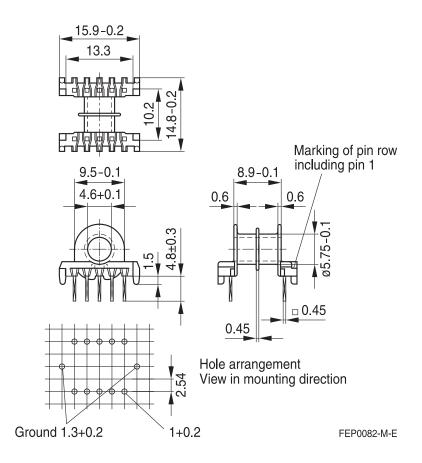
#### EP 13

#### Accessories

#### Coil former with closed center flange for high-voltage applications

Material:GFR thermosetting plastic (UL 94 V-0, insulation class to IEC 60085:<br/>F  $\triangleq$  max. operating temperature 155 °C), color code black<br/>Sumikon PM 9630® [E41429 (M)], SUMITOMO BAKELITE CO LTDSolderability:to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 sResistance to soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 sWinding:see Processing notes, 2.1Pins:Squared pins

Sections	A <sub>N</sub> mm <sup>2</sup>	l <sub>N</sub> mm	$A_R$ value $\mu\Omega$	Terminals	Ordering code
2	13.9	23.8	58.9	10	B65844X1010D002



Please read *Cautions and warnings* and *Important notes* at the end of this document.

5

B65844



## EP 13

Accessories

#### Mounting assembly

The set comprises a yoke and a clamp

#### Yoke

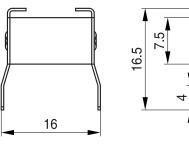
Made of cold rolled steel (0.4 mm) with ground terminal (tinned)

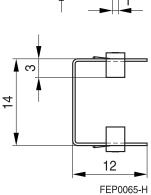
#### Clamp

Spring clamp, made of bronze (0.3 mm), tinned

	Ordering code
Complete mounting assembly	B65844S2000X000

#### Yoke



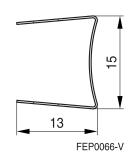


Dimensional tolerances +/-0,2

Dimensions in mm

## Clamp





Please read *Cautions and warnings* and *Important notes* at the end of this document.

6

B65844



#### Cautions and warnings

#### Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast temperature changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see data book, chapter "General - Definitions, 8.1".

#### Effects of core combination on A<sub>L</sub> value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see data book, chapter "General - Definitions, 8.1".

#### Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

#### **NiZn-materials**

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

#### **Ferrite Accessories**

Our ferrite accessories have been designed and evaluated only in combination with our ferrite cores. We explicitly point out that our ferrite accessories or our ferrite cores may not be compatible with those of other manufacturers. Any such combination requires prior testing by the customer and will be at the customer's own risk.

We assume no warranty or reliability for the combination of our ferrite accessories with cores and other accessories from any other manufacturer.

#### **Processing remarks**

The start of the winding process should be soft. Else the flanges may be destroyed.

- Too strong winding forces may blast the flanges or squeeze the tube that the cores can not be mounted any more.
- Too long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyde of the tin bath or burned insulation of the wire. For detailed information see chapter *"Processing notes"*, section 2.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.



#### **Cautions and warnings**

#### Display of ordering codes for TDK Electronics products

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8



## Symbols and terms

Symbol	Meaning	Unit
A	Cross section of coil	mm <sup>2</sup>
A <sub>e</sub>	Effective magnetic cross section	mm <sup>2</sup>
AL	Inductance factor; $A_L = L/N^2$	nH
A <sub>L1</sub>	Minimum inductance at defined high saturation ( $\cong \mu_a$ )	nH
A <sub>min</sub>	Minimum core cross section	mm <sup>2</sup>
A <sub>N</sub>	Winding cross section	mm <sup>2</sup>
A <sub>R</sub>	Resistance factor; A <sub>R</sub> = R <sub>Cu</sub> /N <sup>2</sup>	μΩ = 10 <sup>-6</sup> Ω
В	RMS value of magnetic flux density	Vs/m², mT
ΔB	Flux density deviation	Vs/m², mT
Ê	Peak value of magnetic flux density	Vs/m², mT
ΔÂ	Peak value of flux density deviation	Vs/m², mT
B <sub>DC</sub>	DC magnetic flux density	Vs/m², mT
B <sub>R</sub>	Remanent flux density	Vs/m², mT
B <sub>S</sub>	Saturation magnetization	Vs/m², mT
C <sub>0</sub>	Winding capacitance	F = As/V
CDF	Core distortion factor	mm <sup>-4.5</sup>
DF	Relative disaccommodation coefficient DF = $d/\mu_i$	
d	Disaccommodation coefficient	
E <sub>a</sub>	Activation energy	J
f	Frequency	s <sup>−1</sup> , Hz
f <sub>cutoff</sub>	Cut-off frequency	s <sup>–1</sup> , Hz
f <sub>max</sub>	Upper frequency limit	s <sup>−1</sup> , Hz
f <sub>min</sub>	Lower frequency limit	s <sup>–1</sup> , Hz
f <sub>r</sub>	Resonance frequency	s <sup>–1</sup> , Hz
f <sub>Cu</sub>	Copper filling factor	
g	Air gap	mm
H	RMS value of magnetic field strength	A/m
Ĥ	Peak value of magnetic field strength	A/m
H <sub>DC</sub>	DC field strength	A/m
H <sub>c</sub>	Coercive field strength	A/m
h	Hysteresis coefficient of material	10 <sup>–6</sup> cm/A
h/µ <sub>i</sub> ²	Relative hysteresis coefficient	10 <sup>–6</sup> cm/A
I	RMS value of current	A
I <sub>DC</sub>	Direct current	A
Î	Peak value of current	A
J	Polarization	Vs/m <sup>2</sup>
k	Boltzmann constant	J/K
k <sub>3</sub>	Third harmonic distortion	
k <sub>3c</sub>	Circuit third harmonic distortion	
L	Inductance	H = Vs/A



## Symbols and terms

Symbol	Meaning	Unit
ΔL/L	Relative inductance change	Н
L <sub>0</sub>	Inductance of coil without core	Н
L <sub>H</sub>	Main inductance	Н
Lp	Parallel inductance	Н
L <sub>rev</sub>	Reversible inductance	Н
Ls	Series inductance	Н
l <sub>e</sub>	Effective magnetic path length	mm
I <sub>N</sub>	Average length of turn	mm
Ν	Number of turns	
P <sub>Cu</sub>	Copper (winding) losses	W
P <sub>trans</sub>	Transferrable power	W
P <sub>V</sub>	Relative core losses	mW/g
PF	Performance factor	
Q	Quality factor (Q = $\omega L/R_s$ = 1/tan $\delta_L$ )	
R	Resistance	Ω
R <sub>Cu</sub>	Copper (winding) resistance (f = 0)	Ω
R <sub>h</sub>	Hysteresis loss resistance of a core	Ω
∆R <sub>h</sub>	R <sub>h</sub> change	Ω
R <sub>i</sub>	Internal resistance	Ω
R <sub>p</sub>	Parallel loss resistance of a core	Ω
R <sub>s</sub>	Series loss resistance of a core	Ω
R <sub>th</sub>	Thermal resistance	K/W
R <sub>V</sub>	Effective loss resistance of a core	Ω
S	Total air gap	mm
Т	Temperature	°C
$\Delta T$	Temperature difference	К
Т <sub>С</sub>	Curie temperature	°C
ť	Time	s
t <sub>v</sub>	Pulse duty factor	
tan δ	Loss factor	
tan δ <sub>l</sub>	Loss factor of coil	
tan δ <sub>r</sub>	(Residual) loss factor at $H \rightarrow 0$	
tan δ <sub>e</sub>	Relative loss factor	
tan δ <sub>h</sub>	Hysteresis loss factor	
tan δ/μ <sub>i</sub>	Relative loss factor of material at $H \rightarrow 0$	
U	RMS value of voltage	V
Û	Peak value of voltage	V
V <sub>e</sub>	Effective magnetic volume	mm <sup>3</sup>
Z	Complex impedance	Ω
Z <sub>n</sub>	Normalized impedance $ Z _n =  Z  / N^2 \times \varepsilon (I_e / A_e)$	Ω/mm

10 10/22



## Symbols and terms

Symbol	Meaning	Unit	
χ	Temperature coefficient (TK)		
$\alpha_{F}$	Relative temperature coefficient of material	1/K	
α <sub>e</sub>	Temperature coefficient of effective permeability	1/K	
<sup>e</sup> r	Relative permittivity		
Φ	Magnetic flux	Vs	
1	Efficiency of a transformer		
JB	Hysteresis material constant	mT <sup>-1</sup>	
li	Hysteresis core constant	A-1H-1/2	
s	Magnetostriction at saturation magnetization		
ı	Relative complex permeability		
1 <sup>0</sup>	Magnetic field constant	Vs/Am	
ι <sub>a</sub>	Relative amplitude permeability		
lapp	Relative apparent permeability		
l <sub>e</sub>	Relative effective permeability		
ι <sub>i</sub>	Relative initial permeability		
ι <sub>p</sub> '	Relative real (inductive) component of $\overline{\mu}$ (for parallel components)		
ι <sub>p</sub> "	Relative imaginary (loss) component of $\overline{\mu}$ (for parallel components)		
ι <sub>r</sub>	Relative permeability		
l <sub>rev</sub>	Relative reversible permeability		
ι <sub>s</sub> '	Relative real (inductive) component of $\overline{\mu}$ (for series components)		
ι <sub>s</sub> "	Relative imaginary (loss) component of $\overline{\mu}$ (for series components)		
<sup>1</sup> tot	Relative total permeability		
	derived from the static magnetization curve		
)	Resistivity	$\Omega m^{-1}$	
CI/A	Magnetic form factor	mm <sup>-1</sup>	
Cu	DC time constant $\tau_{Cu} = L/R_{Cu} = A_L/A_R$	S	
ΰ	Angular frequency; $\omega$ = 2 $\Pi$ f	s <sup>-1</sup>	

All dimensions are given in mm.

Surface-mount device



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